

# Specification

P/N: \_\_\_\_\_LUW503F43

### ◆ Features:

- High speed response.
- High reliability and long life.
- Low power consumption.
- Suitable for pulse operation.
- This product doesn't contain restriction Substance comply ROHS standard.

## ◆ Descriptions:

- The series specially designed for applications requiring higher brightness.
- Superior performance in outdoor environment.

## ♦ Applications:

- These lamp are widely used for various application.
- Board for display.
- Indication of all kinds.

## ◆ Selection Guide:

Part No.		Lens Type		
	Material	<b>Emitting Color</b>	Lens Type	
LUW503F43	InGaN	Ultra Super White	Water Clear	

\*Pay attention to electrostatic (ESD)



# ◆ Package Dimensions:



#### **NOTES:**

- 1. All dimensions are in millimetres (mm).
- 2. Tolerance is  $\pm 0.25$  mm(0.01") unless otherwise noted.

Parameter	Symbol	Ultra Super White	Unit
Power Dissipation	Pd	80	mW
Pulse Forward Current	I <sub>FP</sub>	100	mA
DC Forward Current	I <sub>F</sub>	20	mA
Reverse Voltage	VR	5	V
Operating Temperature Range	Topr	-40 ~ +85	°C
Storage Temperature Range	Tstg	-40 ~ +100	°C
Soldering Temperature	Tsol	260 ± 5	°C

# ◆ Absolute Maximum Rating (Ta=25℃)

**Notes:** Soldering time  $\leq$  5 seconds.

 $I_{FP}$  condition: pulse width  $\leq 1$ ms ,duty cycle  $\leq 1/10$ . Tsol condition : 3mm for the base of the epoxy bulb.

Deveryor	Demonster		Ultra Super White			<b>T</b> T •4	<b></b>
Parameter		Symbol M	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity		Iv	7000		15000	mcd	I <sub>F</sub> =20mA
Forward Voltage		V <sub>F</sub>	3.0		3.4	v	I <sub>F</sub> =20mA
Reverse Current		I <sub>R</sub>			50	uA	V <sub>R</sub> =5V
Peak Emission Wavelength		λp	446		454	nm	I <sub>F</sub> =20mA
Viewing Angle		2 0 <sub>1/2</sub>		30		deg	I <sub>F</sub> =20mA
	x			0.29			I <sub>F</sub> =20mA
Chromaticity Coordinate	у			0.29			I <sub>F</sub> =20mA

# ◆ Electrical Optical Characteristics (Ta=25℃)

Notes: 1. Tolerance of Luminous Intensity  $\pm 10\%$ 

- 2. Tolerance of Dominant Wavelength  $\pm 2nm$
- 3. Tolerance of Forward voltage  $\pm 0.05V$

4. Luminous Intensity is measured

equipment on bare chips

# ♦ BIN range

Luminous intensity (tolerance is $\pm 10\%$	@ If =20mA ):
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BIN CODE	Min.(mcd)	Max. (mcd)
W	7000	9000
X	9000	11500
Y	11500	15000

# Peak wavelength (tolerance is $\pm 2nm$ @ If =20mA):

BIN CODE	Min.(nm)	Max. (nm)
D	446	448
Е	448	450
F	450	452
G	452	454

Forward voltage (tolerance is  $\pm 0.05$ V @ If =20mA):

BIN CODE	Min.(V)	Max. (V)
Т	3.0	3.1
U	3.1	3.2
V	3.2	3.3
W	3.3	3.4

Bin				X	,Y			
Code	XT	YT	X <sub>R</sub>	Y <sub>R</sub>	X <sub>B</sub>	Y <sub>B</sub>	XL	YL
BP	0.28	0.26	0.29	0.27	0.28	0.28	0.27	0.27
BR	0.28	0.28	0.29	0.29	0.28	0.30	0.27	0.29
BS	0.29	0.27	0.30	0.28	0.29	0.29	0.28	0.28
BT	0.29	0.29	0.30	0.30	0.29	0.31	0.28	0.30
BU	0.30	0.28	0.31	0.29	0.30	0.30	0.29	0.29
WD	0.30	0.30	0.31	0.31	0.30	0.32	0.29	0.31

Bin range of Chromaticity Coordinates (tolerance is  $\pm 0.01$  @ If =20mA):

• Please refer to CIE 1931 Chromaticity diagram





# • Chromaticity Coordinates & Bin grading diagram: $(I_F=20mA)$

# ♦ Reliability

NO	Test Item	Test Conditions	Sample	Ac/ Re
1	Temperature Cycle	Cycle $\begin{array}{c} -40\pm5^{\circ}\mathbb{C} \rightarrow 25\pm5^{\circ}\mathbb{C} \rightarrow 100\pm5^{\circ}\mathbb{C} \rightarrow 25\pm5^{\circ}\mathbb{C} \\ (30\text{min}, 5\text{min}, 30\text{min}, 5\text{min}) 100 \text{ Cycles} \end{array}$		0/1
2	High Temperature Storage	Ta: 100±5℃ Test time=1000HRS(-24HRS,+72HRS)	20	0/1
3	High Temperature And High Humidity Working	Ta: 85±5°C, RH:85±5%, IF=20mA		0/1
4	Low Temperature Storage	Ta: -40±5℃ Test time=1000HRS(-24HRS,+72HRS)	20	0/1
5	Operating Life Test	Connect with a power IF=20mA Ta=Under room temperature Test time=1000HRS(-24HRS,+72HRS)	20	0/1
6	Solder Resistance	ResistanceT.Sol= $260\pm5^{\circ}$ C one time Dwell Time= $10\pm1$ Secs		0/1
7	Thermal Shock	-40±5℃→100±5℃ (15min, 15min) 100 Cycles	20	0/1

# (1) Test Items and Conditions

# (2)Criteria of judging the damage

Item	Symbol Test condition	Symbol	Samukal Tast and distant Crit		Criteria for judgement	
Item		Test condition	Min.	Max.		
Forward voltage	VF	IF=20 mA	IF=20 mA /			
Reverse current	IR	VR=5V	/	15uA		
Luminous intensity	IV	IF=20 mA	L.S.L*0.7	/		
Wave length	$\lambda$ D/ $\lambda$ P	IF=20 mA	/	U.S.L±2nm		
Appearance	/	View check	No mechanical damage			

\* U.S.L: Upper standard level

L.S.L: Lower standard level

# ◆ Typical Electro-Optical Characteristics Curves:













#### Label Form Specification



#### Precautions In Use

#### A、Soldering Conditions

- 1. When soldering, leave the minimum clearance between the bottom of the resin and the soldering point.
- 2. Maximum allowable soldering conditions are.

Solder dipping: 260 °C max., 5 seconds max., one time.

Soldering iron: 350 °C max., 5 seconds max., one time.

- 3. Contact between molten solder and the resin must be avoided.
- 4. In soldering, do not put any stress on the lead frame, particularly when heated.

#### **B**、Lead frame Forming and Use

1. When forming leads the leads should be bent at a point at least 3mm from the base of epoxy. Lead forming should be done before soldering.

2. Do not apply any bending stress to the base of the lead. The stress to the base may damage the LEDs characteristics.

3. When mounting the LEDs onto a printed circuit board, the holes on the circuit board should be exactly aligned with the leads of the LEDs.

4. Please avoid conditions which may cause the LED to corrode, tarnish or discolor. This corrosion or discoloration may cause difficulty during soldering operations. It is recommended that the LEDs be used as soon as possible.

5. Please avoid rapid transitions in ambient temperature, especially, in high humidity environments.

#### C、 Storage

1. The LEDs should be stored at  $30^{\circ}$ C or less and 70%RH or less after being shipped from Wenrun and the storage life limits are 3 months. If the LEDs are stored for 3 months or more, they can be stored for a year in a sealed container with a nitrogen atmosphere and moisture absorbent material.

2 Please avoid rapid transitions in ambient temperature, especially , in high humidity environments where condensation can occur.

#### D、 Cleaning

1. When necessary, cheaning should occur only with isopropyl alcohol at room temperature for a duration of no more than one minute . Dry at room temperature before use..

2. Do not clean the LEDs ty the ultrasonic. When it is absolutely necessary , the influence of ultrasonic

cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition. Ultrasonic cleaning shall be pre-qualified to ensure this will not cause damage to the LED.

#### **E**、 Circuit Protection

1. Below the zener reference voltage  $V_Z$ , all the current flows through LED and as the voltage rises to  $V_Z$ , the zener diode "breakdown." If the vlotage tries to rise above  $V_Z$  current flows through the zener branch to keep the voltage at exactly  $V_Z$ .

2. When the LED is connected using serial circuit, if either piece of LED is no light up but current can not flow through causing others to light down. In new design, the LED is parallel with zener diode, if either piece of LED is no light up but current can flow through causing others to light up



#### F. Heat Management

1 . Heat management of LEDs must be taken into consideration during the design stage of LED application. The current should be de-rated appropriately by referring to the de-rating curve found in each product specification.

2. The temperature surrounding the LED in the application should be controlled. Please refer to the data sheet de-rating curve.

#### G、Static Electricity

1. These products are sensitive to static electricity charge, and users are required to handle with care. Particularly, if an current and or voltage which exceeds the Absolute Maximum Rating of Products is applied, the overflow in energy may cause damage to, or possibly result in electrical destruction of, the Products. The customer is requested to take adequate countermeasures against static electricity charge and surge when handling Products.

2. Proper grounding of Products , use of conductive mat, conductive working uniform and shoes, and conductive containers are effective against static electricity and surge.

3. Ground low-resistance areas where the product contacts, such as metal surfaces of the work platform, with a conductive mat (surface resistance  $10^{6}$ - $10^{8} \Omega$ ).

4. A tip of soldering iron is requested to be grounded. An ionizer should also be installed where risk of static generation is high.

## ♦ Notes:

1. Above specification may be changed without notice. We will reserve authority on material change for above specification.

2. When using this product, please observe the absolute maximum ratings and the instructions for the specification sheets. We assume no responsibility for any damage resulting from use of the product which does not comply with the instructions included in the specification sheets.